



THE BIG DEAL

- Insertion Loss, 0.9 dB Typ.
- Stop Band Rejection, 46 dB Typ.
- Pass Band Return Loss, 19 dB Typ.
- 0805 Surface Mount Footprint
- Power Handling: 3 Watts



Generic photo used for illustration purposes only

APPLICATIONS

- Harmonic Rejection
- VHF/UHF Transmitters / Receivers
- Test and Measurement
- Telecommunications & Broadband Wireless Applications
- Satcom Modems

FUNCTIONAL DIAGRAM



PRODUCT OVERVIEW

Mini-Circuits' LFCG-360+ is a miniature low temperature co-fired ceramic (LTCC) low pass filter with a DC to 360 MHz passband supporting a variety of applications. This model provides 0.9 dB typical insertion loss over a wide band due to its rugged monolithic construction. Housed in an 0805 ceramic form factor which is ideal for dense signal chain PCB layouts where it complements MMIC size and performance. The LTCC fabrication process assures minimal RF performance variation while delivering a product that is well suited for environmental extremes of high humidity and temperature.

KEY FEATURES

Features	Advantages
Ultra-wide stopband	The LTCC lowpass filter provides a very good stopband rejection until 8500 MHz suitable for wide band applications.
LTCC Construction	Provides repeatable performance in a rugged, ceramic package well suited for tough environments such as high humidity and temperature extremes.
Small size, 0805	Saves space in dense circuit board layouts and minimizes the effects of parasitics.
Rugged Power handling, 3 Watts	Handles up to 3 Watts in a small 0805 package.



LTCC SURFACE MOUNT

Low Pass Filter

LFCG-360+

50Ω DC to 360 MHz

ELECTRICAL SPECIFICATIONS^{1,2,3} AT +25°C

Parameter		F#	Frequency (MHz)	Min.	Typ.	Max.	Units
Pass Band	Insertion Loss	DC-F1	DC - 360	—	0.9	1.6	dB
	Freq. Cut-Off ⁴	F2	500	—	3.0	—	dB
	Return Loss	DC-F1	DC - 360	—	19	—	dB
Stop Band	Rejection	F3-F4	630 - 830	20	37	—	dB
		F4-F5	830 - 1500	37	46	—	
		F5-F6	1500 - 3000	35	43	—	
		F6-F7	3000 - 8500	—	20	—	

1. Tested in Evaluation Board P/N TB-LFCG-360+

2. This filter is bi-directional RF1 and RF2 ports may be interchanged, see S-Parameters for actual performance.

3. In applications where DC voltage and/or current is present at either the input or output ports, external DC blocking capacitors are required.

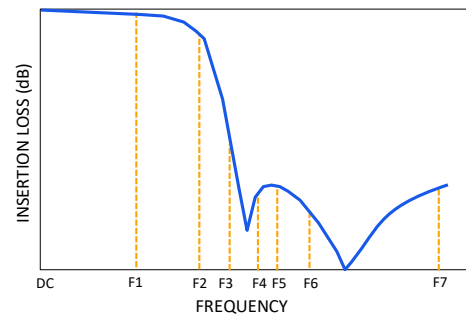
4. Typical variation $\pm 5\%$.ABSOLUTE MAXIMUM RATINGS⁵

Parameter	Ratings
Operating Temperature	-55 °C to +125 °C
Storage Temperature	-55 °C to +125 °C
Input Power ⁶	3 W @25°C

5. Permanent damage may occur if any of these limits are exceeded.

6. Power rating applies only to signals within the passband. Power rating above +25°C operating temperature decreases linearly to 0.7 W at +125°C.

TYPICAL FREQUENCY RESPONSE





LTCC SURFACE MOUNT

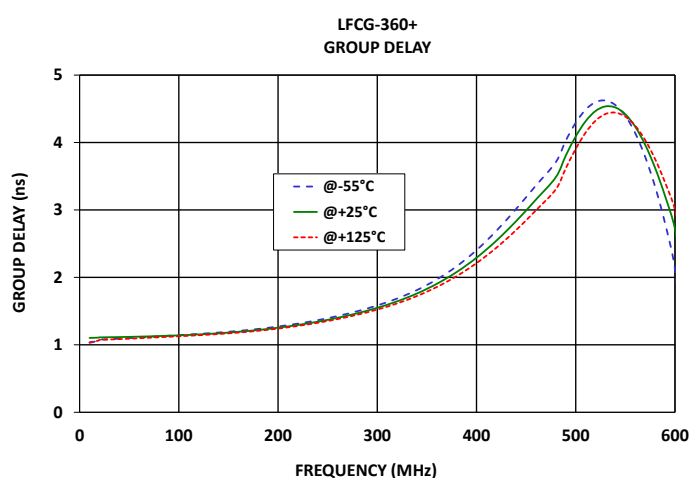
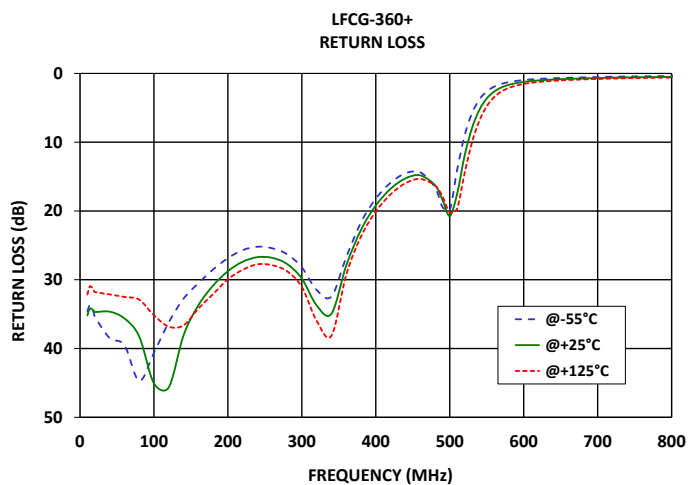
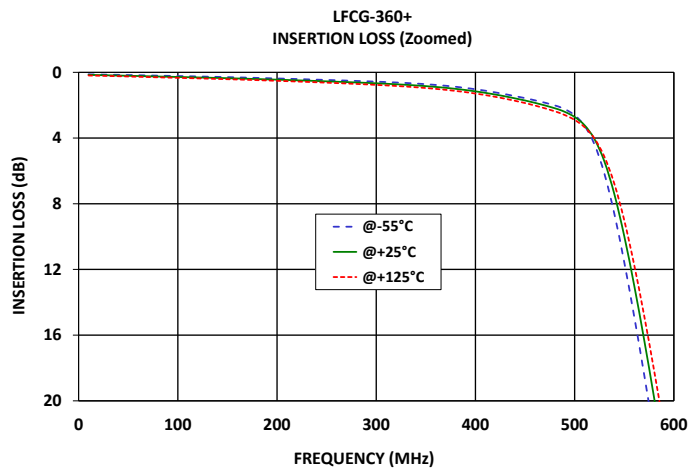
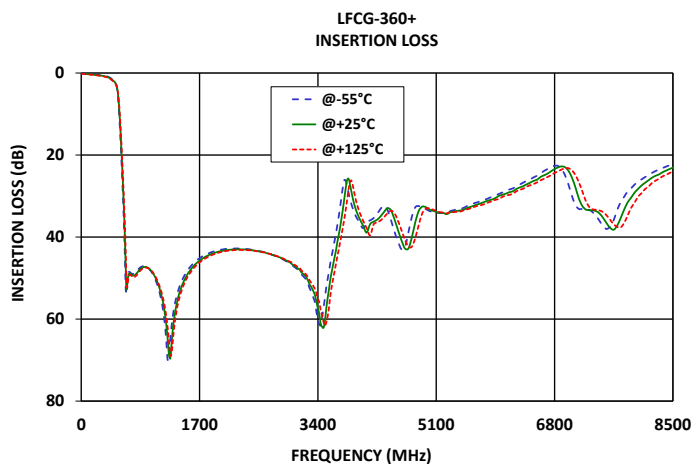
Low Pass Filter

LFCG-360+

Mini-Circuits

50Ω DC to 360 MHz

TYPICAL PERFORMANCE GRAPHS





Mini-Circuits

LTCC SURFACE MOUNT

Low Pass Filter

LFCG-360+

50Ω DC to 360 MHz

FUNCTIONAL DIAGRAM

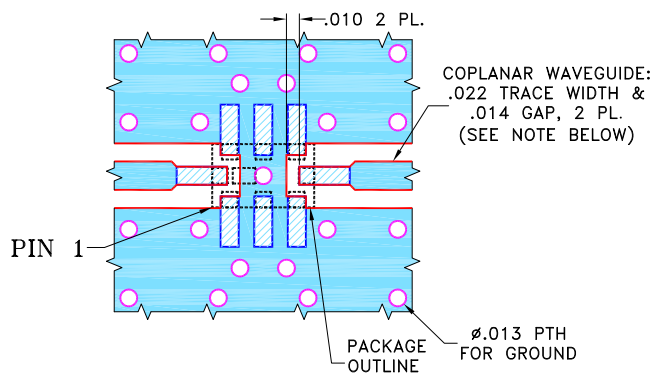


Figure 1. LFCG-360+ Functional Diagram

PAD DESCRIPTION

Function	Pad Number	Description
RF ₁ (Note 2)	8	Connects to RF Input Port
RF ₂ (Note 2)	4	Connects to RF Output Port
GROUND	1,2,3,5,6,7	Connects to Ground on PCB, (See drawing PL-429)
NC	—	No connection, not used internally. See drawing PL-429 for connection to PCB

SUGGESTED PCB LAYOUT (PL-429)



NOTES:

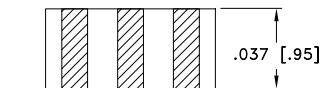
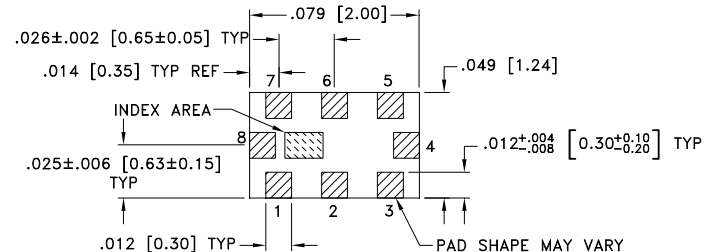
1. COPLANAR WAVEGUIDE IS SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS $.010" \pm .001"$. COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

 DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).

 DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

Figure 2. Suggested PCB Layout PL-429

CASE STYLE DRAWING


 METALLIZATION

Weight: .008 grams

Dimensions are in inches (mm). Tolerances: 2Pl. $\pm .01$; 3 Pl. $\pm .005$

PRODUCT MARKING*: WF

*Marking may contain other features or characters for internal lot control.



Mini-Circuits

LTCC SURFACE MOUNT

Low Pass Filter

LFCG-360+

50Ω DC to 360 MHz

ADDITIONAL DETAILED INFORMATION IS AVAILABLE ON OUR DASH BOARD.

[CLICK HERE](#)

Performance Data and Graphs	Data
	Graphs
	S-Parameter (S2P Files) Data Set (.zip file) De-embedded to device pads
Case Style	GE0805C-2 Lead Finish: Nickel-Tin
RoHS Status	Compliant
Tape and Reel	TR-F114
Suggested Layout for PCB Design	98-PL-429
Evaluation Board	TB-LFCG-360+
	Gerber File
Environmental Rating	ENV06T11

NOTES

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuits' applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits' standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html



Typical Performance Data

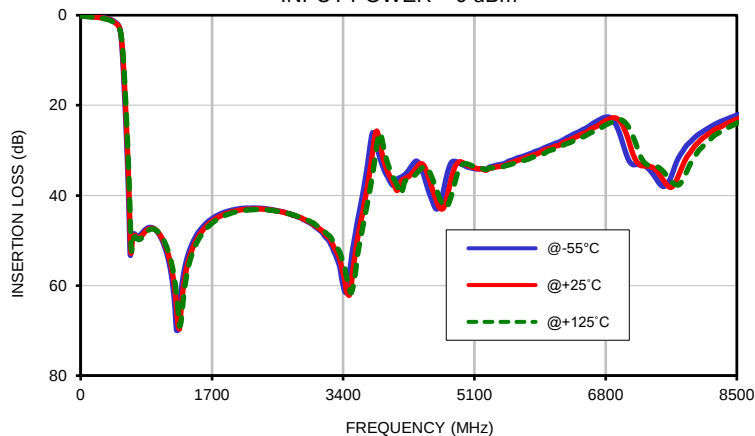
FREQ.	INSERTION LOSS			INPUT RETURN LOSS			OUTPUT RETURN LOSS		
	(dB)			(dB)			(dB)		
(MHz)	@-55°C	@+25°C	@+125°C	@-55°C	@+25°C	@+125°C	@-55°C	@+25°C	@+125°C
10	0.12	0.15	0.19	34.58	35.20	32.15	35.25	35.66	32.50
20	0.13	0.17	0.21	35.37	34.70	31.80	34.63	33.99	31.45
16	0.13	0.16	0.20	34.11	34.26	31.08	34.33	34.29	31.26
40	0.15	0.20	0.24	38.48	34.64	32.13	34.47	32.09	30.54
60	0.18	0.22	0.27	39.49	35.62	32.50	30.74	29.67	28.29
80	0.20	0.25	0.30	44.70	38.24	32.90	28.86	28.02	26.87
100	0.23	0.28	0.33	40.60	45.07	35.17	26.60	26.33	25.32
120	0.25	0.31	0.37	36.20	45.66	36.82	25.20	24.90	24.24
140	0.28	0.34	0.40	32.75	38.08	36.63	23.66	23.51	23.00
160	0.31	0.37	0.44	30.51	33.72	34.19	22.48	22.42	22.05
180	0.34	0.41	0.47	28.51	30.84	32.08	21.55	21.57	21.25
200	0.37	0.45	0.52	26.86	28.75	29.93	21.01	21.04	20.80
220	0.41	0.49	0.56	25.69	27.38	28.55	20.83	20.82	20.61
240	0.45	0.53	0.60	25.20	26.72	27.75	20.87	20.85	20.65
260	0.48	0.57	0.65	25.43	26.82	27.89	21.38	21.34	21.12
280	0.52	0.62	0.71	26.29	27.71	28.76	22.44	22.42	22.09
300	0.57	0.67	0.76	28.20	29.83	31.05	24.83	24.59	24.07
320	0.62	0.73	0.83	31.49	33.73	35.98	29.68	28.68	27.44
340	0.68	0.80	0.91	32.43	34.94	38.13	43.04	35.82	32.40
360	0.77	0.89	1.01	26.72	27.94	29.29	27.91	28.60	28.61
380	0.88	1.01	1.13	21.66	22.74	23.71	21.55	22.34	22.85
400	1.03	1.16	1.29	18.22	19.20	20.08	17.74	18.47	19.00
420	1.22	1.35	1.49	15.90	16.78	17.58	15.27	15.93	16.41
440	1.45	1.59	1.73	14.54	15.27	15.97	13.89	14.41	14.80
460	1.70	1.86	2.02	14.37	14.82	15.34	13.80	14.00	14.22
480	2.01	2.19	2.37	16.56	16.25	16.29	15.80	15.19	14.96
490	2.24	2.41	2.60	19.39	18.34	17.86	17.90	16.63	15.99
500	2.61	2.72	2.90	19.88	20.73	20.23	18.20	17.86	17.13
630	46.67	41.87	38.63	0.74	0.95	1.15	2.44	2.95	3.48
730	49.00	49.28	49.58	0.46	0.60	0.72	1.24	1.53	1.83
770	48.78	49.29	49.71	0.41	0.54	0.64	0.92	1.15	1.38
810	48.05	48.57	49.01	0.37	0.49	0.59	0.69	0.87	1.06
830	47.68	48.15	48.57	0.35	0.47	0.56	0.60	0.76	0.93
900	47.09	47.31	47.53	0.29	0.39	0.48	0.38	0.50	0.62
830	47.68	48.15	48.57	0.35	0.47	0.56	0.60	0.76	0.93
1100	52.04	51.28	50.86	0.18	0.28	0.34	0.13	0.20	0.28
1200	61.14	58.51	56.97	0.15	0.23	0.30	0.07	0.14	0.21
1300	61.42	65.37	68.11	0.12	0.20	0.27	0.04	0.10	0.16
1400	52.69	54.21	55.55	0.10	0.18	0.24	0.01	0.08	0.13
1500	48.85	49.86	50.61	0.08	0.16	0.22	0.01	0.07	0.12
1600	46.61	47.35	47.92	0.06	0.14	0.20	0.01	0.06	0.12
1700	45.16	45.74	46.19	0.04	0.13	0.18	0.01	0.05	0.10
1800	44.18	44.67	45.03	0.03	0.11	0.17	0.01	0.05	0.10
1900	43.53	43.93	44.24	0.02	0.11	0.15	0.01	0.05	0.10
2000	43.10	43.44	43.69	0.01	0.09	0.14	0.01	0.05	0.10
2200	42.81	43.04	43.18	0.01	0.08	0.12	0.01	0.06	0.11
2400	42.95	43.11	43.20	0.01	0.07	0.11	0.00	0.07	0.12
2600	43.58	43.63	43.65	0.03	0.06	0.09	0.01	0.08	0.14
2800	44.69	44.65	44.59	0.01	0.07	0.10	0.01	0.09	0.16
3000	46.42	46.21	46.04	0.04	0.05	0.08	0.03	0.11	0.18
3200	49.75	49.14	48.70	0.00	0.08	0.11	0.03	0.12	0.20
3400	59.99	57.37	55.14	0.00	0.09	0.12	0.06	0.15	0.24
3600	44.47	48.36	51.94	0.05	0.12	0.15	0.11	0.19	0.28
3800	26.31	28.04	33.29	0.19	0.26	0.24	1.50	1.36	0.72
4000	36.67	35.58	34.00	0.23	0.28	0.31	0.12	0.25	0.42
4500	38.70	35.67	34.18	1.74	3.16	4.85	0.08	0.21	0.35
5000	33.64	33.24	32.98	0.81	1.45	2.54	0.12	0.27	0.42
5500	32.84	33.28	33.43	0.31	0.46	0.57	0.19	0.35	0.50
6000	29.50	29.97	30.72	0.41	0.55	0.67	0.27	0.43	0.58
8500	22.19	23.08	23.96	0.81	1.10	1.44	1.14	1.15	1.19

Typical Performance Data

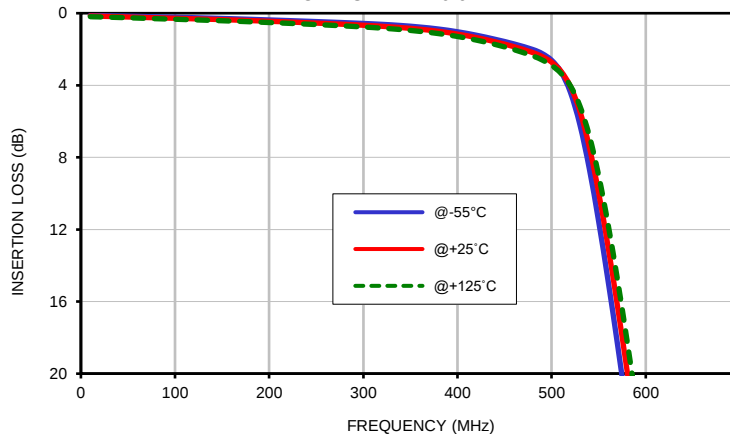
FREQ.	GROUP DELAY		
(MHz)	(nsec)		
	@-55°C	@+25°C	@+125°C
10.00	1.03	1.10	1.04
13.00	1.04	1.10	1.05
16.00	1.05	1.11	1.05
19.00	1.06	1.11	1.06
20.00	1.08	1.11	1.07
40.00	1.09	1.12	1.08
60.00	1.11	1.12	1.10
80.00	1.13	1.13	1.11
100.00	1.14	1.14	1.13
120.00	1.16	1.15	1.14
140.00	1.18	1.17	1.16
160.00	1.21	1.19	1.18
180.00	1.24	1.22	1.21
200.00	1.27	1.25	1.24
220.00	1.32	1.30	1.28
240.00	1.37	1.34	1.33
260.00	1.43	1.40	1.38
280.00	1.50	1.47	1.45
300.00	1.58	1.55	1.52
320.00	1.69	1.64	1.61
340.00	1.81	1.76	1.72
360.00	1.97	1.91	1.86

Typical Performance Curves

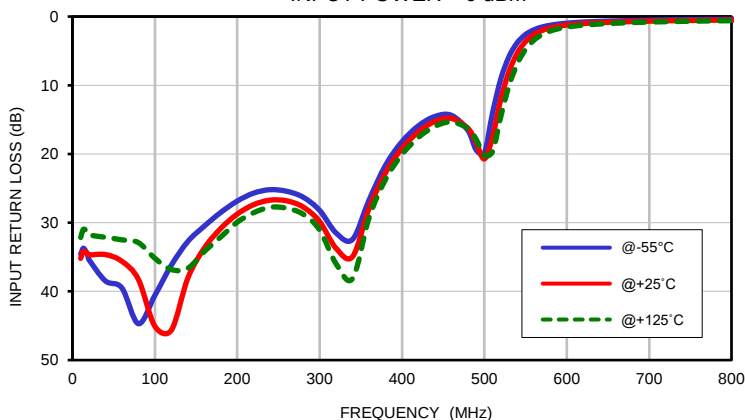
INSERTION LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm



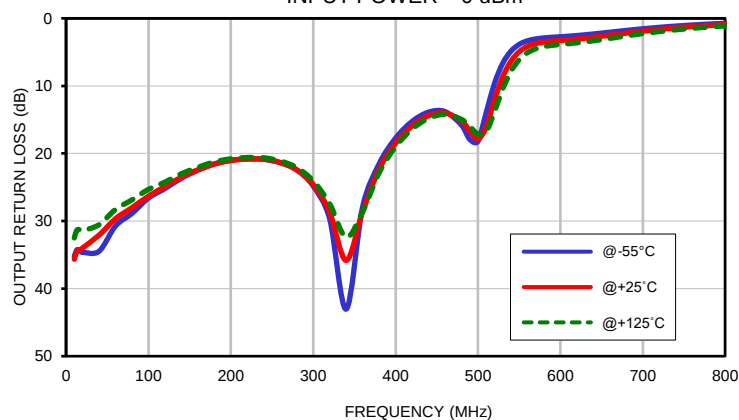
INSERTION LOSS vs. TEMPERATURE (Zoomed)
INPUT POWER = 0 dBm



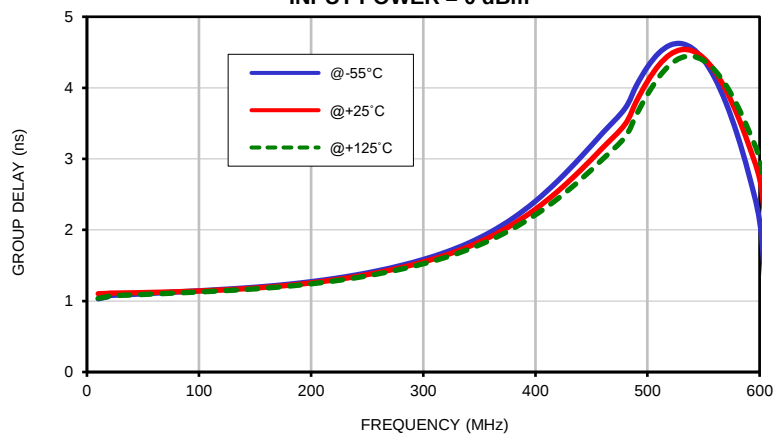
INPUT RETURN LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm



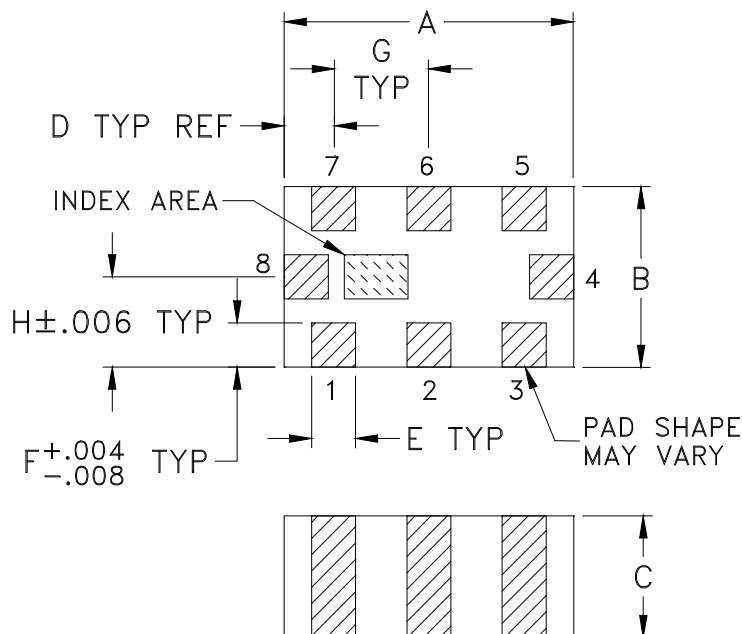
OUTPUT RETURN LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm



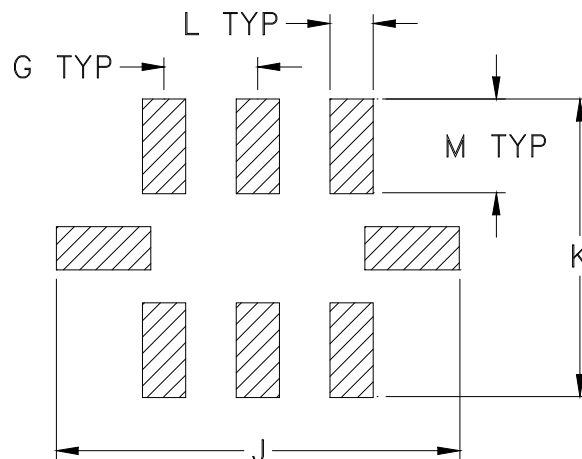
GROUP DELAY vs. TEMPERATURE
INPUT POWER = 0 dBm



Outline Dimensions



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm .002$

CASE #	A	B	C	D	E	F	G	H	J	K	L
GE0805C-2	.079 (2.00)	.049 (1.25)	.037 (0.95)	.014 (0.35)	.012 (0.30)	.012 (0.30)	.026 (0.65)	.025 (0.63)	.134 (3.40)	.110 (2.80)	.014 (0.35)

CASE #	M	WT. GRAM
GE0805C-2	.039 (1.00)	.008

Dimensions are in inches (mm). Tolerances: 2Pl. $\pm .01$; 3 Pl. $\pm .005$

Notes:

1. Open style, ceramic base.
2. Termination finish: For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
For RoHS-5 Case Styles: Tin-Lead plate over Nickel plate. All models, no (+) suffix.
3. Pad tolerance to be non-cumulative. Minimum spacing between each pad is .004 (0.1).



P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site



Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

RF/IF MICROWAVE COMPONENTS

Tape & Reel Packaging TR-F114

DEVICE ORIENTATION IN T&R

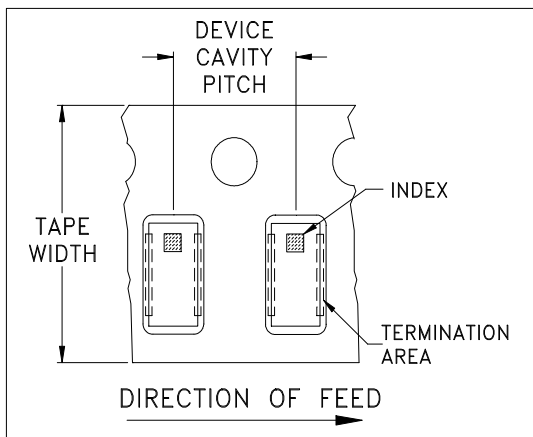


ILLUSTRATION 1

Applicable Case Styles	
GE0805C	JC0603C
GE0805C-1	JC0603C-4
GE0805C-1AP	JC0603C-6
GE0805C-7	
GE0805C-9	
GE0805C-10	
GE0805C-11	
GE0805C-12	

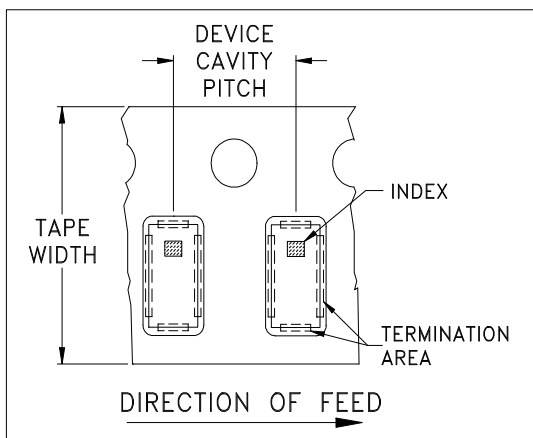


ILLUSTRATION 2

Applicable Case Styles	
GE0805C-2	JC0603C-1
GE0805C-3	JC0603C-2
GE0805C-4	JC0603C-3
GE0805C-5	JC0603C-5
GE0805C-6	JC0603C-7
GE0805C-8	JV1210C-1
GE0805C-15	

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
8	4	7	Small quantity standards (see note)	20
				50
				100
				200
				500
				1000
			Standard	4000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



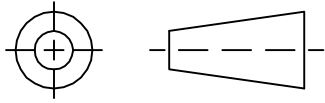
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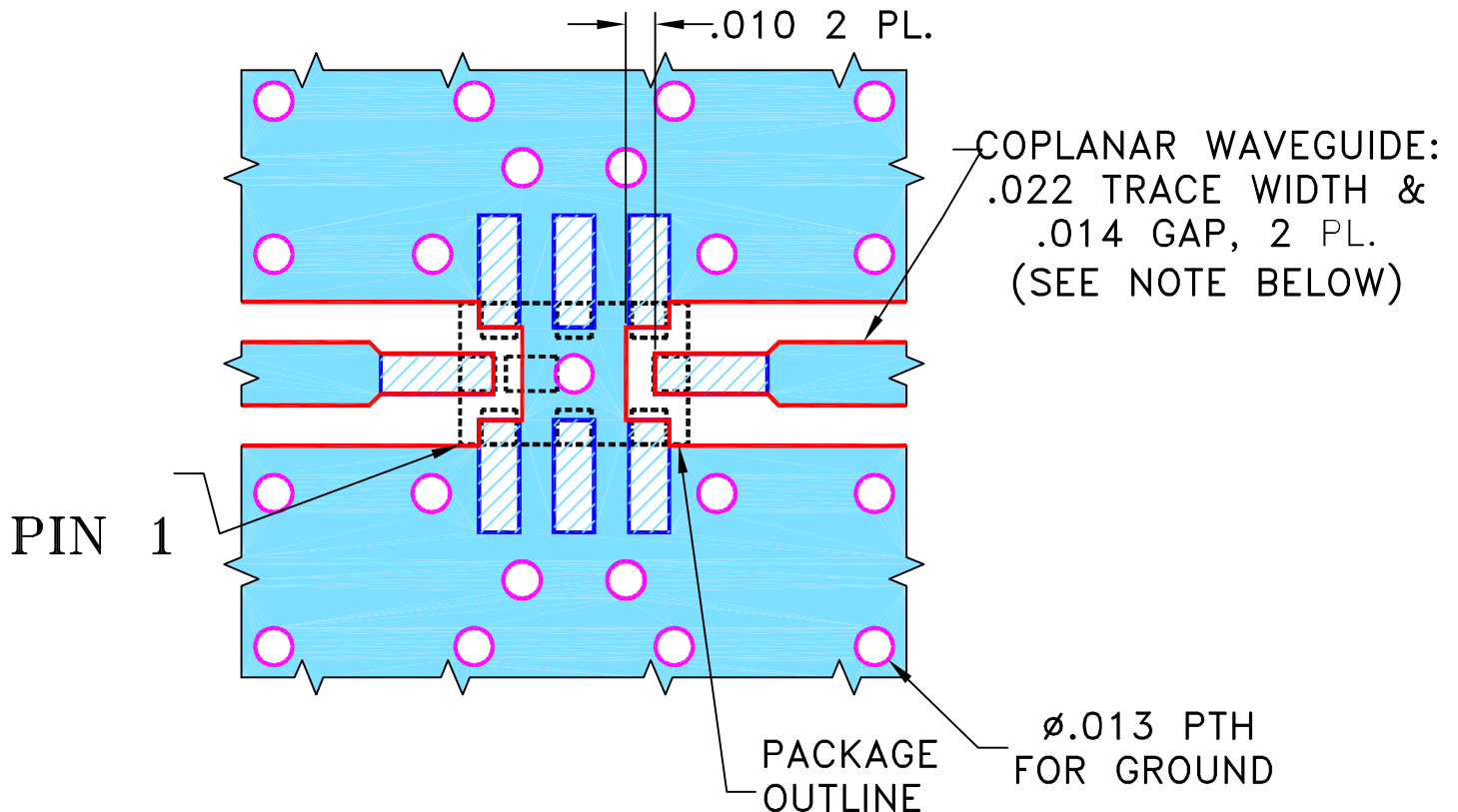
THIRD ANGLE PROJECTION



REVISIONS

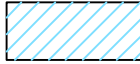
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M148457	NEW RELEASE	10/14/14	GF	MY

SUGGESTED MOUNTING CONFIGURATION
FOR GE0805C-4 CASE STYLE, "08FL07" PIN CODE

NOTES:

1. COPLANAR WAVEGUIDE IS SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS .010" $\pm$.001". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

 DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).

 DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

UNLESS OTHERWISE SPECIFIED

DIMENSIONS ARE IN INCHES

TOLERANCES ON:

2 PL DECIMALS $\pm$ 3 PL DECIMALS $\pm$.005ANGLES $\pm$ FRACTIONS $\pm$

INITIALS

DATE

DRAWN

GF

10/01/14

CHECKED

IL

10/14/14

APPROVED

MY

10/14/14



Mini-Circuits®

13 Neptune Avenue
Brooklyn NY 11235

PL, 08FL07, GE0805C-4, TB-799+

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Mini-Circuits®

ASHEETA1.DWG REV:A DATE:01/12/95

SIZE
ACODE IDENT
15542

DRAWING NO:

98-PL-429

REV:

OR

FILE: 98PL429

SCALE:

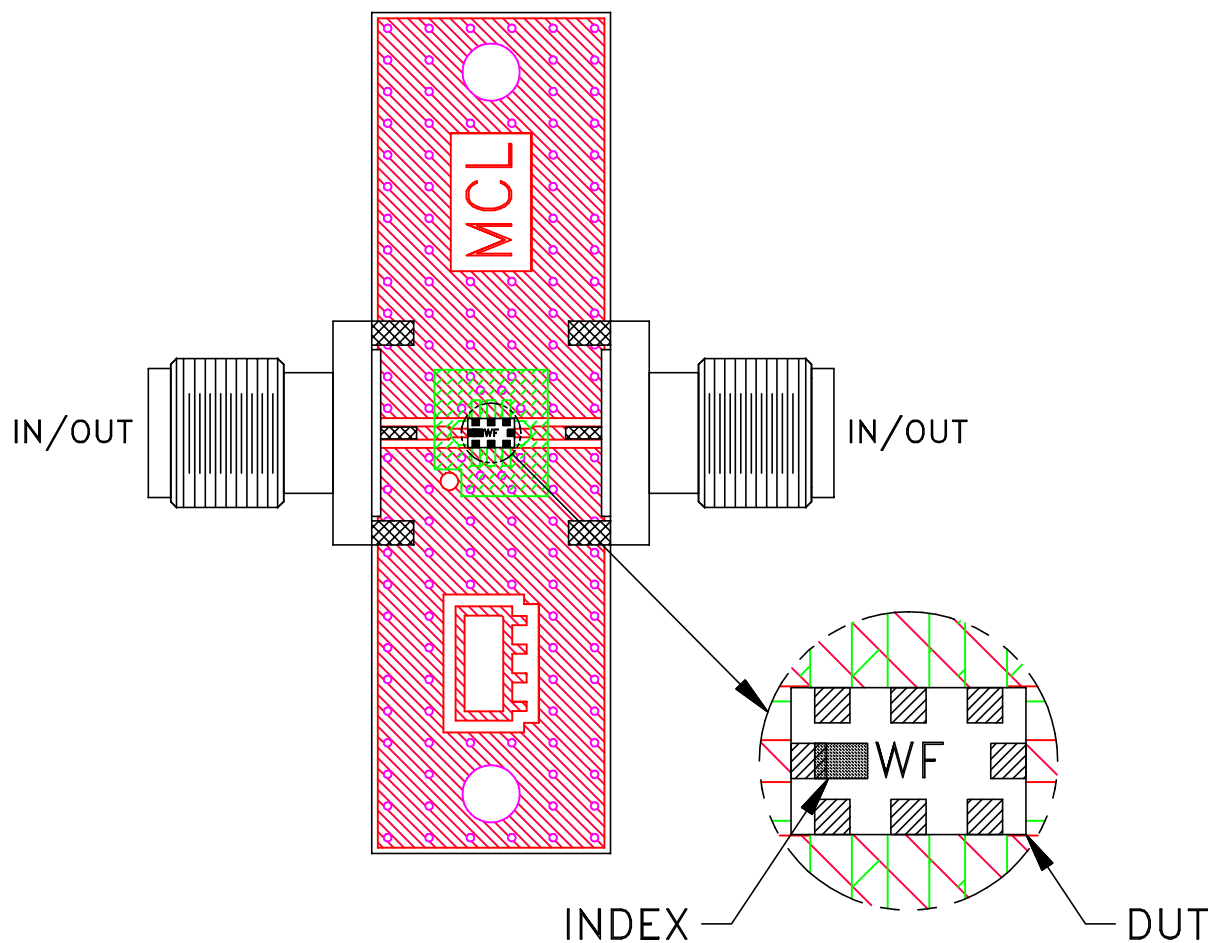
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SHEET:

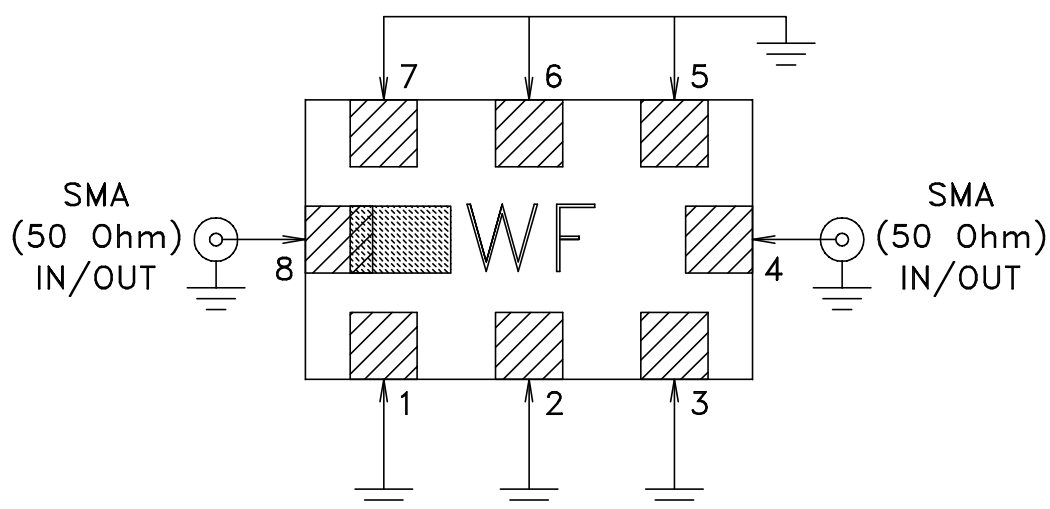
1 OF 1

Evaluation Board and Circuit

TB-LFCG-360+



Schematic diagram



Notes:

1. PCB Material: ROGERS (R04350) OR Equivalent, Dielectric Constant=3.5
Dielectric Thickness: .010 inch
2. 50 Ohm SMA Female Connectors.

 **Mini-Circuits®**



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Test B,B1, 95% Coverage
Thermal Shock	-40° to +125°C, 15 min dwell, 100 cycles	MIL-STD-202, Method 107
Bend Test	1mm, deflection for 5 seconds Span of bending: 2.75"	--
High Temp Storage	125°C to 1000 Hrs	---